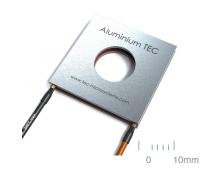




# THERMOELECTRIC COOLER PERFORMANCE

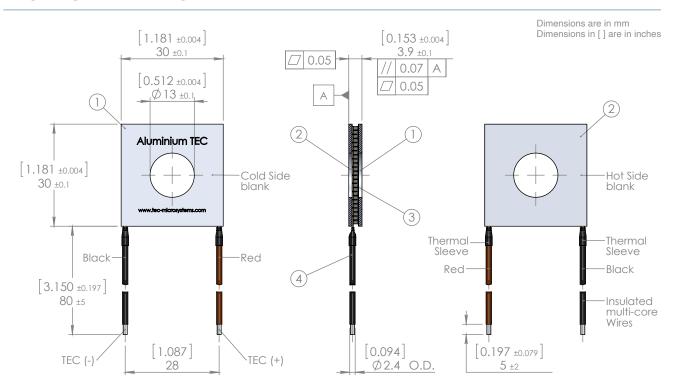


ΔTmax K	Qmax W	Imax A	Umax V	ACR Ohm	Ambient Temperature	Conditions
72	61.4	3.8	26.7	5.3	+27°C / 300K	Vacuum
77	66.6	3.7	29.3	6.0	+50°C / 323K	Dry N2
82	71.4	3.6	32.1	6.7	+75°C / 348K	Dry N2
84	73.3	3.6	33.1	6.9	+85°C / 358K	Dry N2

 $\underline{Note} {:} \ Thermoelectric \ Cooler \ performance \ values \ are \ specified \ for \ optimal \ conditions, \ assuming \ that \ TEC \ hot \ side \ (T_{hot}) \ is \ stabilized \ at \ ambient \ temperature \ (T_{amb})$ 

# **TECHNICAL DRAWING**

# 1MA10-215-12H



# TEC DESCRIPTION

- · Cold Side (1) and Hot Side (2): bare Aluminium
- Internal Assembly: Solder Sn-Sb  $(T_{melt}=230^{\circ}C)$
- Cold Side (1) Surface: blank, Ra<0.8um</li>
- · Hot Side (2) Surface: blank, Ra<0.8um
- Terminal Contacts (4): AWG-18 Wires, silicon insulated color-coded (Red/Black), multi-strand
- Bi-Te Material (3): high-grade, hot-extruded type
- · Moisture Protection: internal Fluoropolymer coating
- · Laser marking: available by request

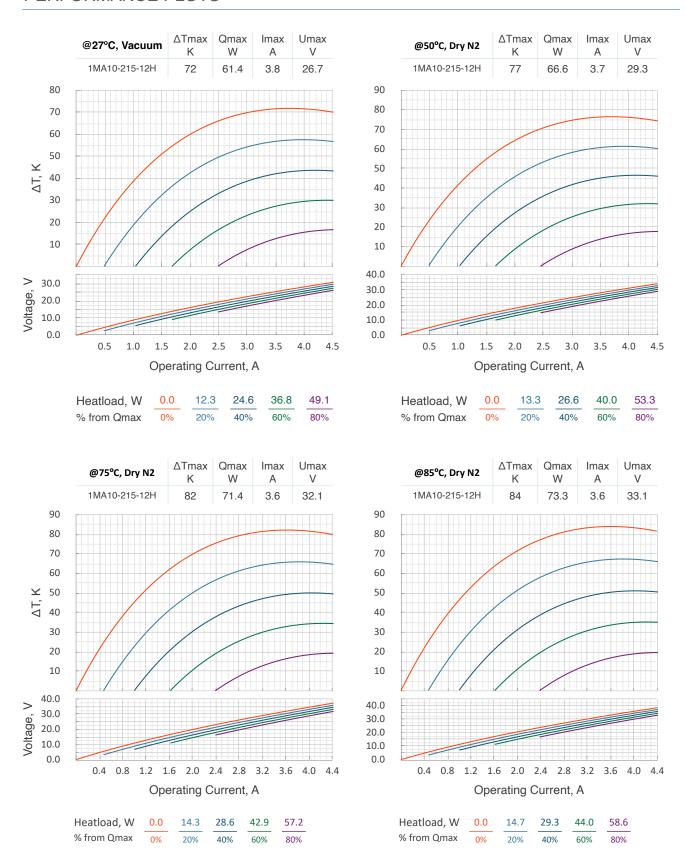
#### **KEY FEATURES**

- · High-Density (HD) pellets placement technology
- Up to 30W/cm<sup>2</sup> TEC Cooling Power density
- Single Center-hole solution
- · Tested to 1M cycles, ideal for cycling applications
- · TELCORDIA GR-468 (MIL-883) qualified
- · Aluminium (metal) plates instead of ceramics
- Up to 225°C short time processing (for mounting)
- Additional manufacturing options (see Pages 3,4)
- RoHS EU Compliant, REACH EU Compliant





# PERFORMANCE PLOTS



Note: Thermoelectric cooler performance values and plots are specified at optimal conditions, assuming TEC hot side is stabilized at ambient temperature  $(T_{hot}=T_{amb})$ . The performance data is specified for four most common ambient condition modes. Please, contact TEC Microsystems GmbH directly for estimations under different conditions, if required.





# TEC TERMINAL CONNECTION OPTIONS

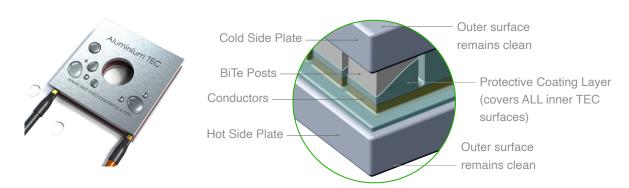


By default thermoelectric cooler is provided with silicon insulated AWG-18 flexible multicore terminal wires.
 The alternative configuration with terminal lamellas is a free option, if TEC terminal wires are customized or have to be soldered by Customer later.

# MOISTURE PROTECTION (TEC PROTECTIVE COATING BY DEFAULT)

- ✓ Thin fluoropolymer protective layer
- ✓ No impact on TEC performance
- ✓ Non-toxic

- ✓ Covers ALL inner TEC surfaces
- ✓ Withstands up to 220°C processing
- √ VOC-free



 The 1MA10 thermoelectric coolers come standard with a fluoropolymer coating to protect against moisture and condensation. Alternative solution with TEC Silicone Potting (encapsulation) is available upon request.

# SURFACE LASER MARKING (OPTIONAL)

TEC laser engraving/labelling is an option available upon request. Aluminium plates are easy to process with laser engraving - TEC polarity marks, text/labels, serial numbers, position marks and more. Can be applied to both TEC sides, top and bottom.

TEC Laser engraving with individual serial number can be provided along with individual thermoelectric cooler QC protocol (ACR, Figure-of-Merit and Time Constant specified for each TEC unit).



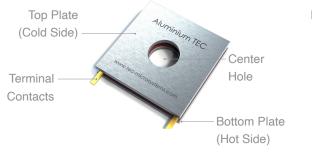




# ADVANCED MOUNTING SOLUTION

#### Standard manufacturing configuration (default)

#### Optional solution with mounting holes

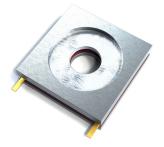




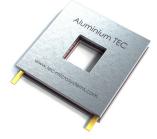
By default Aluminium TECs from 1MA10 Series have the same size of top and bottom plates. Both plates are
made from Aluminium, the recommended mounting methods are gluing and mechanical mounting with a thermal
grease. TEC hot side (or both TEC plates) can be extended and provided with holes for screw mounting.

# DEEP TEC CUSTOMIZATION AND OPTIMIZATION FOR APPLICATION

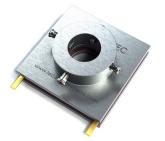
Using metal plates instead of ceramics in thermoelectric cooler construction brings the entirely new dimension in TEC optimization for a final application. Aluminium is easy to machine, thus the advanced options like variable thickness, surface milling, cutout, partial and through- holes, screw mounting and complex 3D surfaces are possible.



 Customized TEC plates thickness & machining



Customized TEC center hole shape



Advanced 3D surface machining & mounting

# ADVANCED TEC MODIFICATIONS FOR NON-FLAT OBJECTS

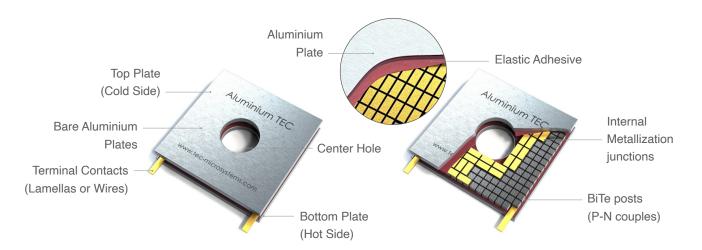


With Aluminium plates in TEC design it's possible to create very special configurations for non-flat objects, like tubes. Combined with the mounting screws, this simplifies many things in the final construction.





# 1MA10 SERIES "ALUMINIUM" TE COOLERS - TECS WITH HOLES OVERVIEW



- 1MA10 Series Thermoelectric Coolers have a unique construction with Aluminium plates instead of ceramics.
- Ultimate fusion of TEC manufacturing technologies with HD pellets placement, bulk BiTe material and Aluminium plates with 30W/cm² cooling power density.
- Aluminium plates simplifies TEC mounting process and match perfectly with standard Aluminium heatsinks by thermal expansion coefficient (CTE).
- TEC internal Assembly Solder by default: Sn-Sb, T<sub>melt</sub>=230°C



Optimal for cycling applications



RoHS Compliant

# **APPLICATION TIPS**

- Maximum short time process temperature is 220°C (TEC assembly solder has T<sub>melt</sub>=230°C).
- Maximum long time operating temperature is 150°C.
- Use thermoelectric cooler only with an appropriate heat sink attached to the hot side.
- Connect thermoelectric cooler to DC power supply in according to TEC polarity.
- Do not exceed DC current and voltage higher than Imax and Umax values.
- Use temperature ramping and avoid thermal shocks during soldering and/or baking processes.
- Check FAQ on TEC Microsystems web for more details about TECs operating and handling.







TEC Lifetime depends on Ambient Temperature (Tamb) and can be estimated by Arrhenius equation



Term "Lifetime" for TEC is taken from Telcordia GR-468 Standard. The criteria of failure is TEC AC Resistance (ACR) change for more than 5%. It doesn't mean TEC stops operating, but certain performance degradation appears.

1MA10-215-12h



# **IMPORTANT NOTES**

- 1. Thermoelectric Cooler (TEC) performance in this datasheet is specified in typical ambient condition modes (Vacuum, +27°C; Dry N2, +50°C; Dry N2, +75°C and Dry N2, +85°C. TEC performance may differ under other conditions. Please, contact TEC Microsystems for for detailed analysis and additional TEC performance info.
- 2. TEC ACR and Umax values are sensitive to ambient temperature. These values can be different from those specified in the datasheet at other ambient conditions. ACR and Umax rise with ambient temperature increasing.
- 3. TEC dTmax is specified at zero heatload, while Qmax is specified at zero dT (check Fig.1 for example). TEC dTmax and Qmax values rise with ambient temperature (check Fig. 2 for example).
- 4. Thermoelectric coolers have the best performance in the temperature range from near room up to +80..90°C. TEC cooling performance is getting lower at ambient temperatures below 0°C. TECs are not suitable to operate at cryogenic temperatures.



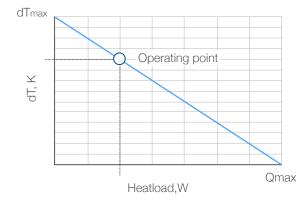
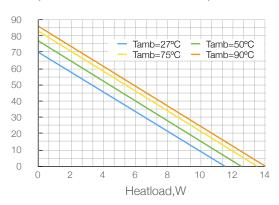


Fig. 2 - Same TEC dTmax and Qmax parameters at different ambient temperatures



- 5. Driving TEC at Imax or Umax level doesn't mean the max cooling performance mode. The real optimal mode may depend on operating conditions, required dT level and application heatload. In fact a better performance can be reached at operating current and voltage lower than Imax and Umax values specified in datasheet.
- 6. Aluminium thermoelectric coolers from 1MA10 Series can be mounted directly on Aluminium or Copper heatsinks. There is no critical CTE mismatch as it happens with standard ceramic TECs in this case. In the case of Aluminum heatsink, there is no CTE mismatch at all. However, it's recommended to avoid such hard joint methods of mounting like epoxy glue. Soft elastic materials for mounting are recommended - thermal pastes/grease or elastic silicon-based thermoconductive adhesives.
- 7. TEC Microsystems GmbH confirms that all thermoelectric coolers are qualified and meet the requirements of Telcordia GR-468 Standard (based on MIL-883). The up-to-date Reliability Report is available by request. TEC Microsystems GmbH warranties thermoelectric coolers lifetime no less than 250K-300K operating hours under normal application conditions.
- 8. Additional information about thermoelectric coolers operating and handling, all the most important questions and answers, are available on TEC Microsystems web in FAQ section (link).





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